



## Material Content Data Sheet



<b>Sales Product Name</b>	TLE6217G			<b>Issued</b>	27. September 2017			
<b>MA#</b>	MA000632948							
<b>Package</b>	PG-DSO-20-37			<b>Weight*</b>	2097.29 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	11.949	0.57	0.57	5697	5697
leadframe	inorganic material	phosphorus	7723-14-0	0.388	0.02		185	
	non noble metal	zinc	7440-66-6	1.552	0.07		740	
	non noble metal	iron	7439-89-6	31.040	1.48		14800	
wire	non noble metal	copper	7440-50-8	1260.343	60.09	61.66	600939	616664
	noble metal	gold	7440-57-5	4.802	0.23	0.23	2290	2290
	encapsulation	organic material	carbon black	1333-86-4	1.527	0.07		728
encapsulation	plastics	epoxy resin	-	70.258	3.35		33499	
	inorganic material	silicondioxide	60676-86-0	691.886	32.99	36.41	329896	364123
leadfinish	non noble metal	tin	7440-31-5	12.535	0.60	0.60	5977	5977
plating	noble metal	silver	7440-22-4	0.958	0.05	0.05	457	457
solder	non noble metal	tin	7440-31-5	0.100	0.00		48	
	noble metal	silver	7440-22-4	0.151	0.01		72	
	non noble metal	lead	7439-92-1	9.799	0.47	0.48	4672	4792
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com